

/ Descriptions

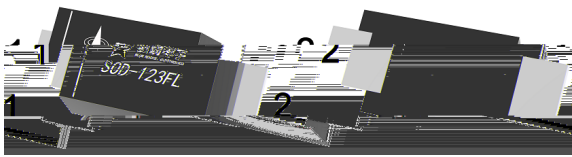
/ Features

/ Applications

/ Equivalent Circuit

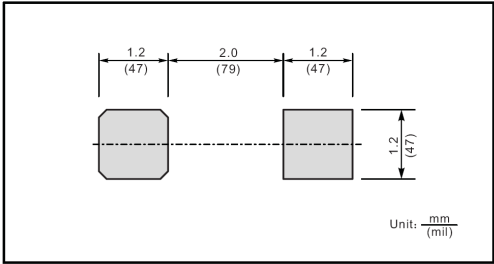


/ Pinning



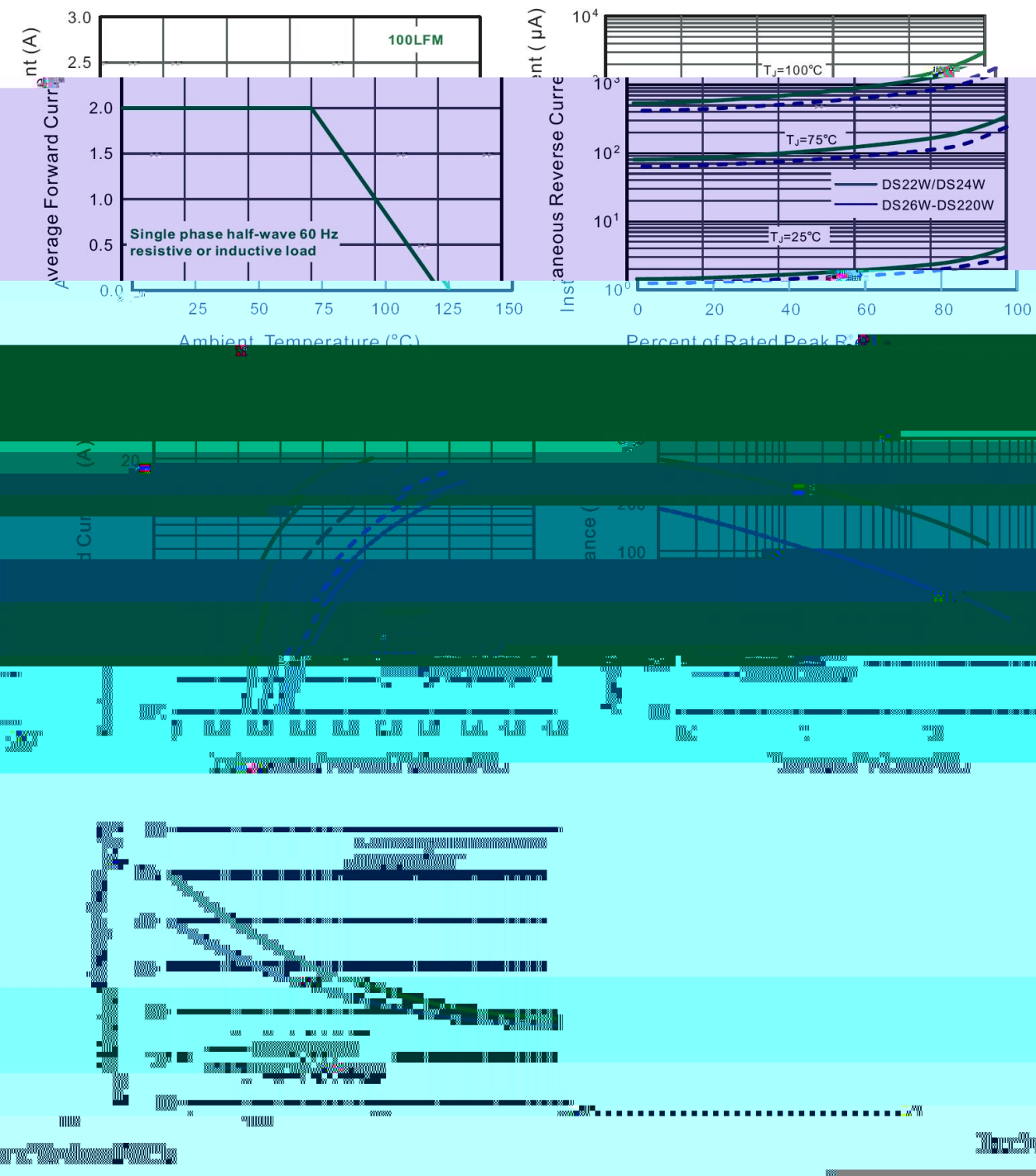
PIN	DESCRIPTION
1	Cathode
2	Anode

The recommended mounting pad size



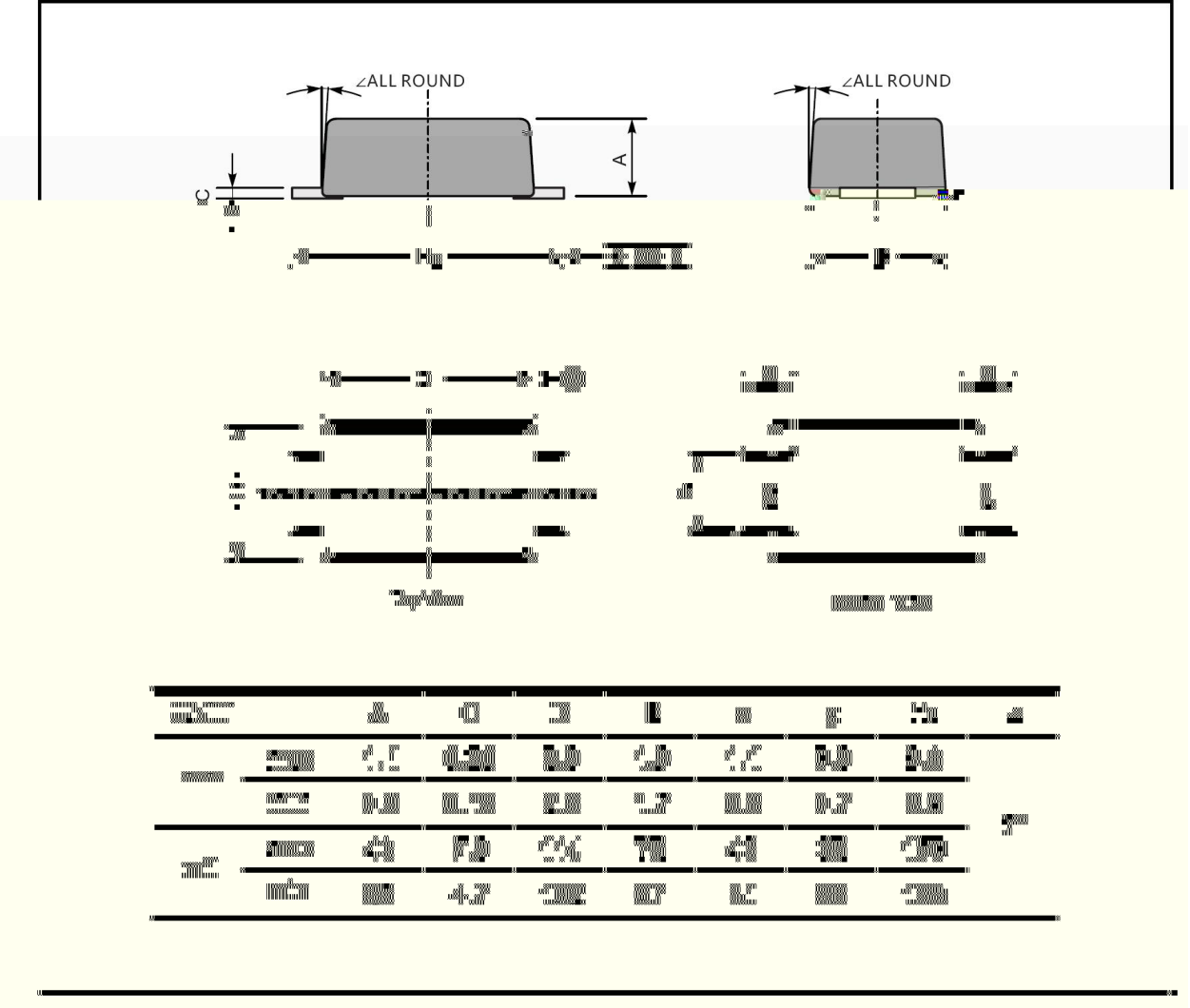
/ Marking

/ Electrical Characteristic Curve

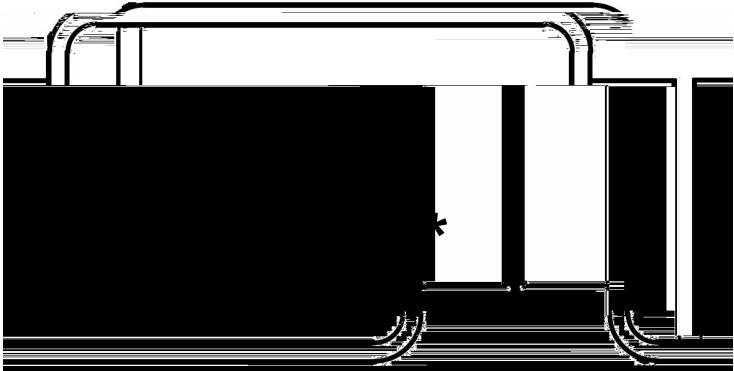


/ Package Dimensions

SOD-123FL

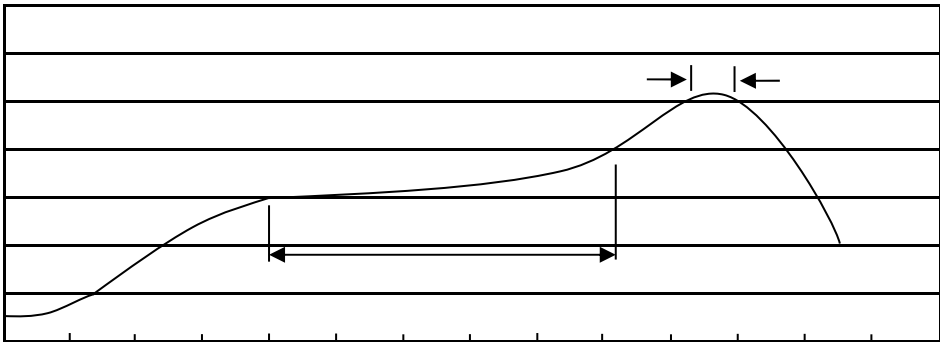


/ Marking Instructions



Marking

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱

/ Notices